



9N95

Power MOSFET

9A, 950V N-CHANNEL POWER MOSFET

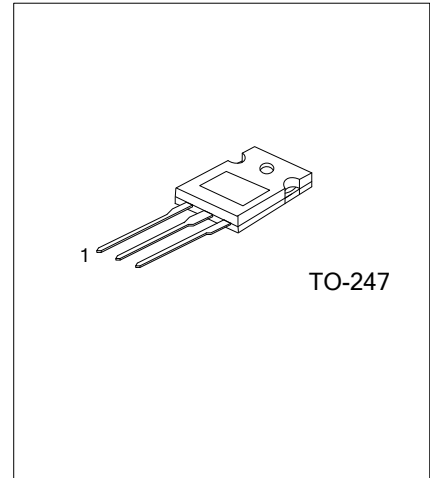
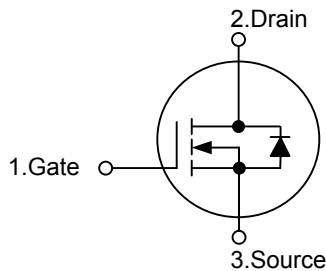
DESCRIPTION

The UTC **9N95** uses UTC's advanced proprietary, planar stripe, DMOS technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with low gate voltages. This device is suitable for use as a load switch or in PWM applications.

FEATURES

- * $R_{DS(ON)} = 1.4\Omega @ V_{GS} = 10V$
- * Ultra Low Gate Charge (Typical 45 nC)
- * Low Reverse Transfer Capacitance ($C_{RSS} = \text{Typical } 14 \text{ pF}$)
- * Fast Switching Capability
- * Avalanche Energy Specified
- * Improved dv/dt Capability, High Ruggedness

SYMBOL



ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
9N95L-T47-T	9N95G-T47-T	TO-247	G	D	S	Tube

<p>9N95L-T47-T</p> <p>(1)Packing Type (2)Package Type (3)Lead Free</p>	<p>(1) T: Tube (2) T47: TO-2475 (3) G: Halogen Free, L: Lead Free</p>
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■ ABSOLUTE MAXIMUM RATING ($T_C = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	950	V
Gate-Source Voltage		V_{GSS}	± 30	V
Continuous Drain Current ($T_C = 25^\circ\text{C}$)		I_D	9.0	A
Pulsed Drain Current (Note 2)		I_{DM}	36	A
Avalanche Current (Note 2)		I_{AR}	9.0	A
Avalanche Energy	Single Pulsed(Note 3)	E_{AS}	900	mJ
	Repetitive(Note 2)	E_{AR}	28	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.0	V/ns
Power Dissipation		P_D	160	W
Linear Derating Factor above $T_C = 25^\circ\text{C}$			1.28	W/ $^\circ\text{C}$
Junction Temperature		T_J	150	$^\circ\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^\circ\text{C}$

Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature

3. $L = 21\text{mH}$, $I_{AS} = 9.0\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\ \Omega$, Starting $T_J = 25^\circ\text{C}$

4. $I_{SD} \leq 9.0\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ_{JA}	50	$^\circ\text{C}/\text{W}$
Junction to Case	θ_{JC}	0.78	$^\circ\text{C}/\text{W}$

■ ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0\text{V}$, $I_D = 250\ \mu\text{A}$	950			V	
Drain-Source Leakage Current	I_{DSS}	$V_{DS} = 950\text{V}$, $V_{GS} = 0\text{V}$			10	μA	
Gate-Body Leakage Current	Forward	I_{GSSF}	$V_{GS} = 30\text{V}$, $V_{DS} = 0\text{V}$			100	nA
	Reverse	I_{GSSR}	$V_{GS} = -30\text{V}$, $V_{DS} = 0\text{V}$			-100	nA
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	$I_D = 250\ \mu\text{A}$, Referenced to 25°C		0.99		$\text{V}/^\circ\text{C}$	
ON CHARACTERISTICS							
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}$, $I_D = 250\ \mu\text{A}$	3.0		5.0	V	
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS} = 10\text{V}$, $I_D = 4.5\text{A}$		1.05	1.4	Ω	
DYNAMIC PARAMETERS							
Input Capacitance	C_{ISS}	$V_{DS} = 25\text{V}$, $V_{GS} = 0\text{V}$, $f = 1.0\text{MHz}$		2100	2730	pF	
Output Capacitance	C_{OSS}			175	230	pF	
Reverse Transfer Capacitance	C_{RSS}			14	18	pF	
SWITCHING CHARACTERISTICS							
Turn-On Delay Time	$t_{D(ON)}$	$V_{DD} = 475\text{V}$, $I_D = 11.0\text{A}$, $R_G = 25\ \Omega$ (Note 1, 2)		50	110	ns	
Turn-On Rise Time	t_R			120	250	ns	
Turn-Off Delay Time	$t_{D(OFF)}$			100	210	ns	
Turn-Off Fall Time	t_F		75	160	ns		
Total Gate Charge	Q_G	$V_{DS} = 760\text{V}$, $I_D = 11.0\text{A}$, $V_{GS} = 10\text{V}$ (Note 1,2)		45	58	nC	
Gate-Source Charge	Q_{GS}			13		nC	
Gate-Drain Charge	Q_{GD}			18		nC	

■ ELECTRICAL CHARACTERISTICS(Cont.)

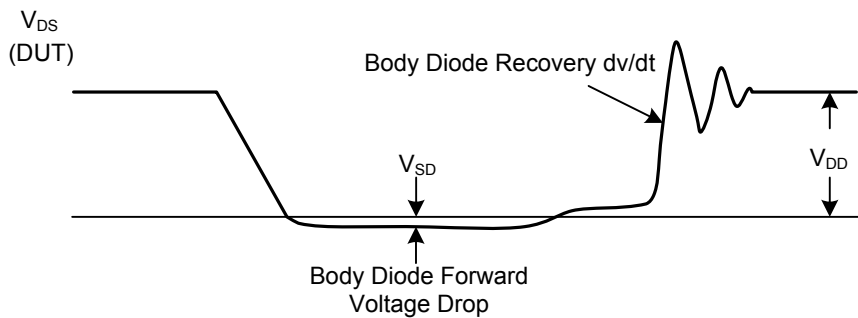
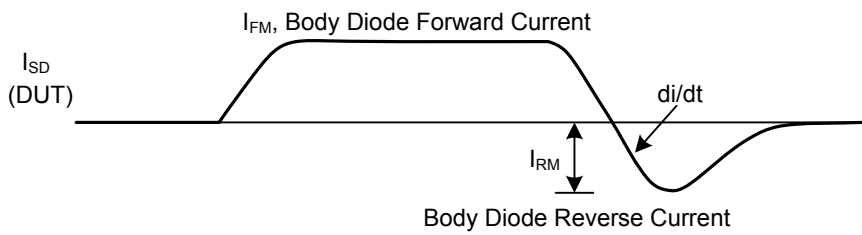
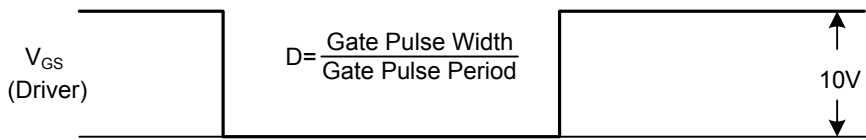
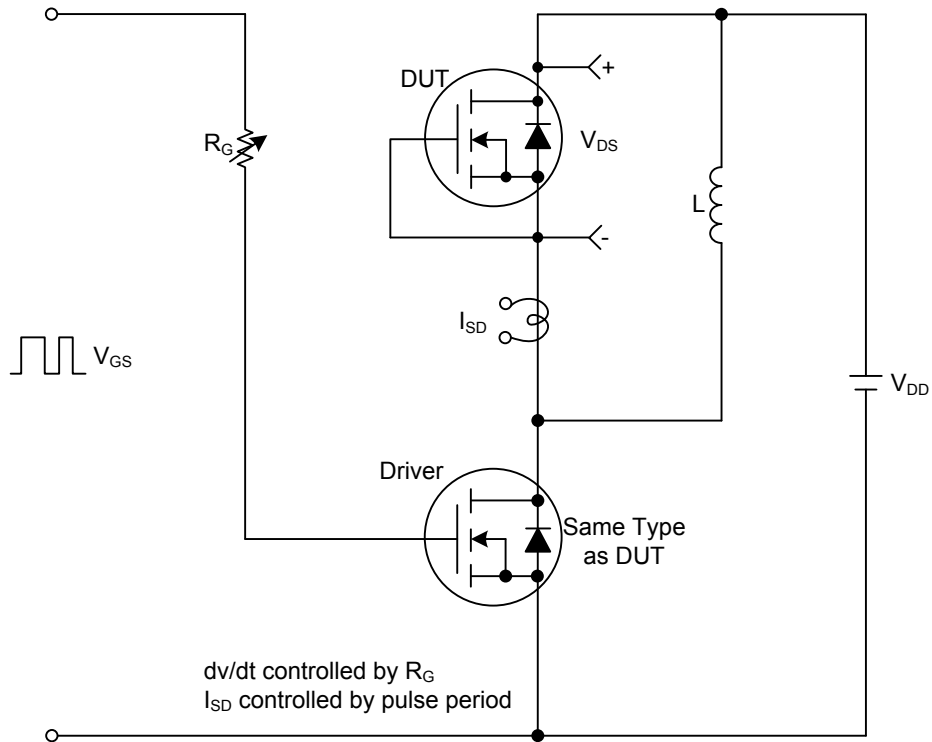
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
Drain-Source Diode Forward Voltage	V_{SD}	$V_{GS} = 0\text{ V}, I_S = 9.0\text{ A}$			1.4	V
Maximum Continuous Drain-Source Diode Forward Current	I_S				9.0	A
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}				36	A
Reverse Recovery Time	t_{rr}	$V_{GS} = 0\text{ V}, I_S = 9.0\text{ A},$		550		ns
Reverse Recovery Charge	Q_{RR}	$dI_F / dt = 100\text{ A}/\mu\text{s}$ (Note 1)		6.5		μC

Notes: 1. Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$

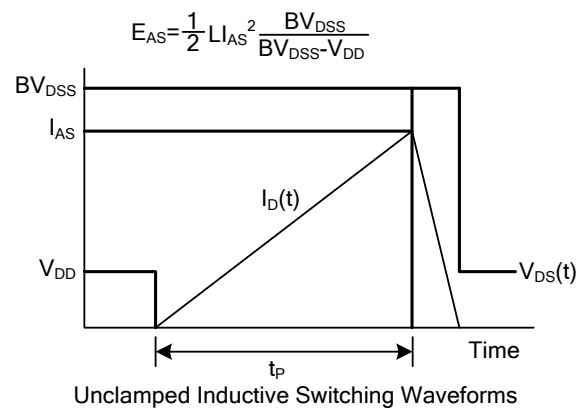
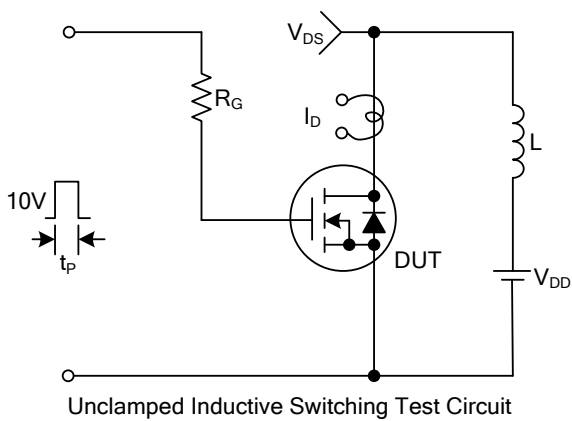
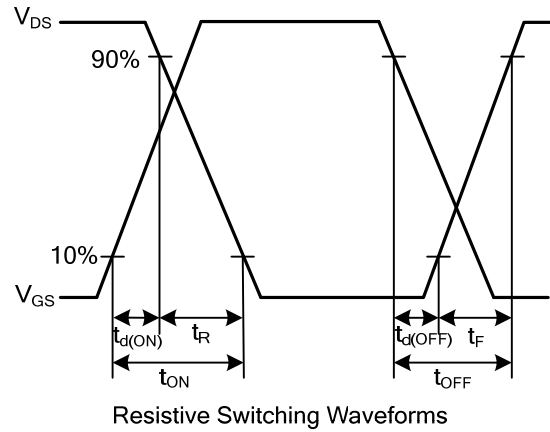
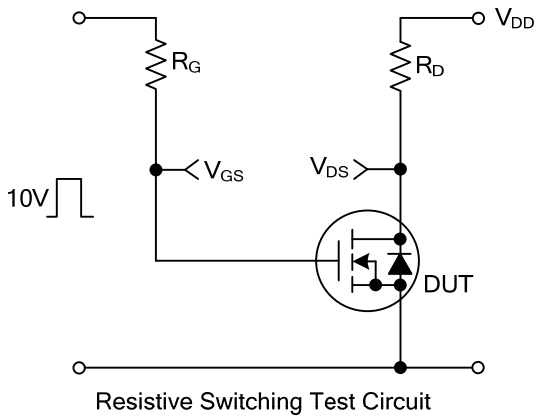
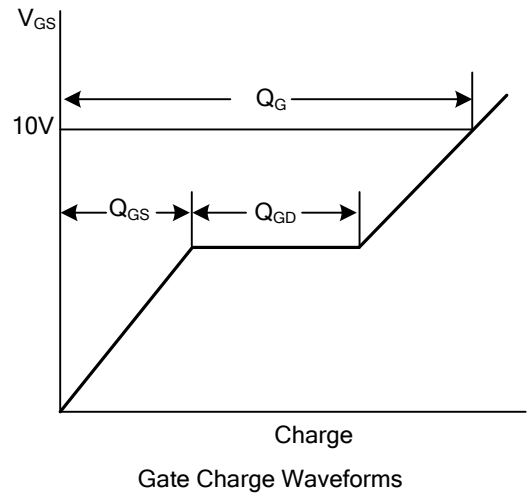
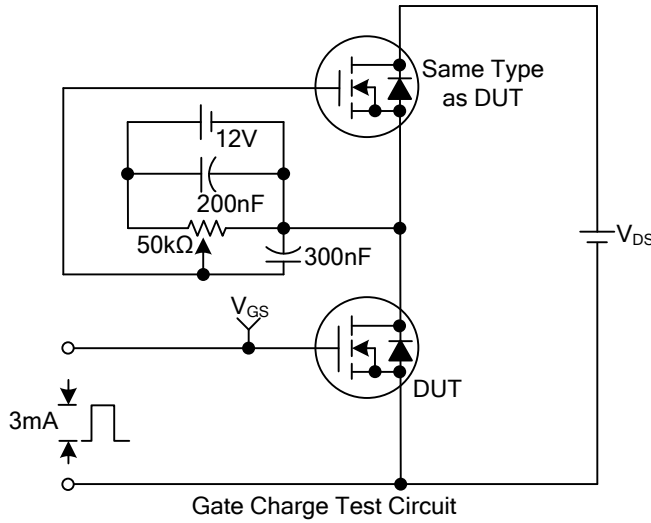
2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

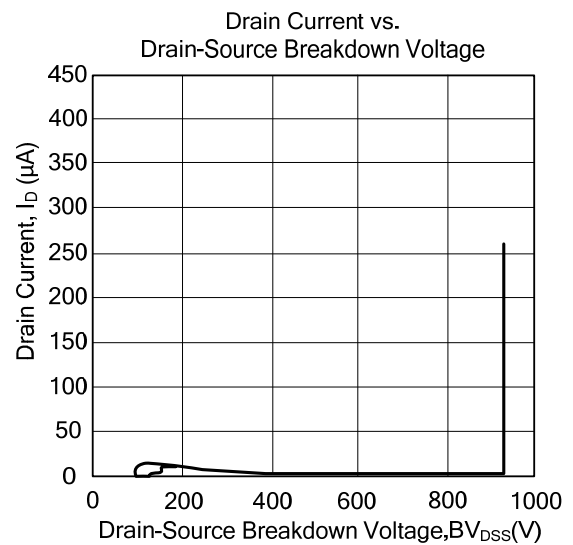
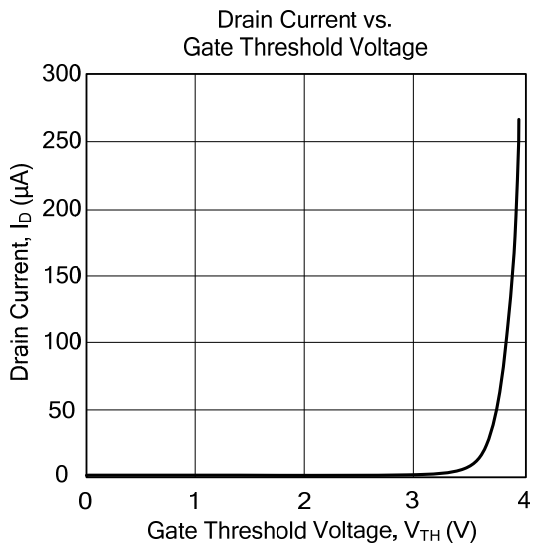
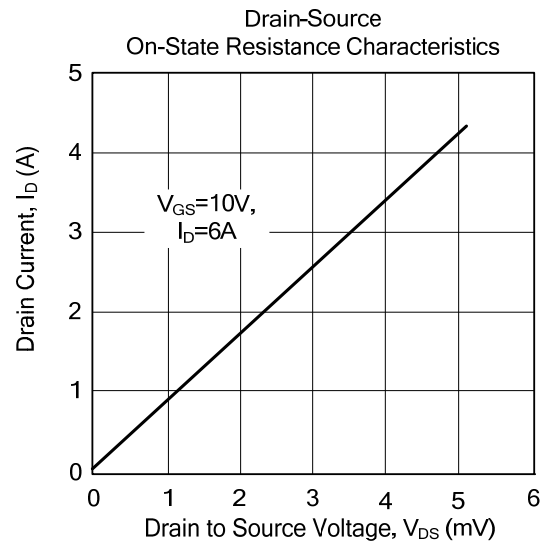
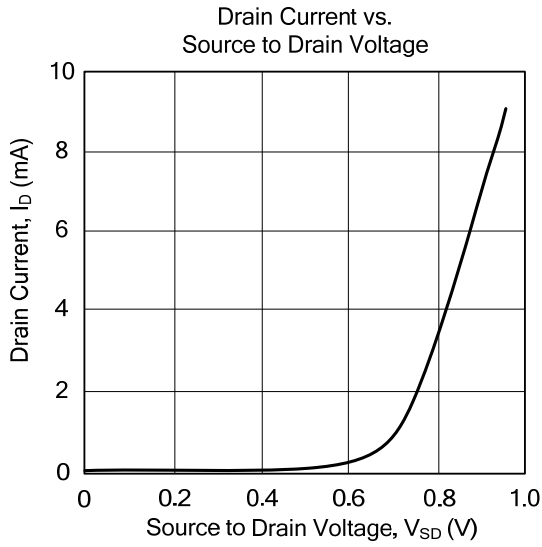
Peak Diode Recovery dv/dt Test Circuit & Waveforms



■ TEST CIRCUITS AND WAVEFORMS(Cont.)



■ TYPICAL CHARACTERISTICS



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